Unit: mm

TOSHIBA Field Effect Transistor Silicon P Channel MOS Type

SSM3J35CTC

○ Analog Switch Applications

• 1.2Vdrive

• ESD(HBM) level 2kV

• Low ON-resistance

 $R_{DS(ON)} = 3.2 \Omega \text{ (typ.) } (@V_{GS} = -1.2 \text{ V})$

 $R_{DS(ON)} = 2.3 \Omega \text{ (typ.) } (@V_{GS} = -1.5 \text{ V})$

 $R_{DS(ON)} = 2.0 \Omega \text{ (typ.) } (@V_{GS} = -1.8 \text{ V})$

 $R_{DS(ON)} = 1.5 \Omega \text{ (typ.) } (@V_{GS} = -2.5 \text{ V})$

 $R_{DS(ON)} = 1.1 \Omega \text{ (typ.) } (@V_{GS} = -4.5 \text{ V})$

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-Source voltage		V _{DSS}	-20	V	
Gate-Source voltage		V _{GSS}	±10	٧	
Drain current (Note1	DC	I _D	-250	mA	
Drain current (Note1)	Pulse	I _{DP}	-600		
Power dissipation (Note2)		P _D	500	mW	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55 to 150	°C	

Note:

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: The channel temperature should not exceed 150°C during use.

Note 2: Mounted on FR4 board

 $(24.5 \text{ mm} \times 24.5 \text{ mm} \times 1.6 \text{ mm}, \text{ Cu Pad: } 645 \text{ mm}^2)$

0.38 +0.02

0.6 ±0.05

Gate
 Source
 Drain

CST3C JEDEC

JEITA —
TOSHIBA 2-1W1A

Weight: 0.55 mg(typ.)

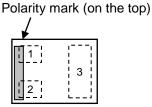
0.5±0.05

BOTTOM VIEW

Marking(top view)

Polarity mark

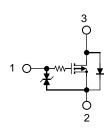
Pin Condition (top view)



- 1. Gate
- 2. Source
- 3. Drain

*Electrodes: On the bottom

Equivalent Circuit



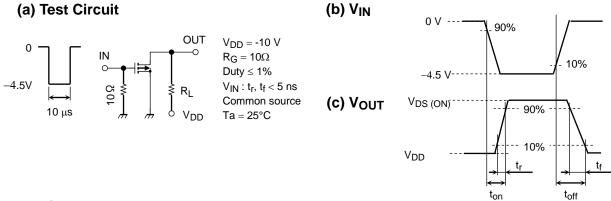
Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain-source breakdown voltage	V (BR) DSS	$I_D = -1 \text{ mA}, V_{GS} = 0 \text{ V}$	-20	_	_	V
	V (BR) DSX	$I_D = -1 \text{ mA}, V_{GS} = 10 \text{ V}$ (Note4)	-10	_	_	V
Drain cut-off current	I _{DSS}	V _{DS} = -20 V, V _{GS} = 0 V	_	—	-1	μΑ
Gate leakage current	I _{GSS}	$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0 \text{ V}$	_	—	±1	μΑ
Gate threshold voltage	V _{th}	$V_{DS} = -10 \text{ V}, I_D = -100 \mu\text{A}$	-0.3	_	-1.0	V
Forward transfer admittance	Y _{fs}	$V_{DS} = -10 \text{ V}, I_{D} = -100 \text{ mA (Note3)}$	_	430	_	mS
Drain-source ON-resistance		$I_D = -150 \text{ mA}, V_{GS} = -4.5 \text{ V (Note3)}$	_	1.1	1.4	Ω
		$I_D = -150 \text{ mA}, V_{GS} = -2.5 \text{ V (Note3)}$	_	1.5	2.1	
	R _{DS} (ON)	$I_D = -50 \text{ mA}, V_{GS} = -1.8 \text{ V}$ (Note3)	_	2.0	2.9	
		$I_D = -20 \text{ mA}, V_{GS} = -1.5 \text{ V}$ (Note3)	_	2.3	4.0	
		I _D = -10 mA, V _{GS} = -1.2 V (Note3)	_	3.2	20	
Input capacitance	C _{iss}		_	21	42	pF
Output capacitance	C _{oss}	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz	_	6	_	
Reverse transfer capacitance	C _{rss}		_	2	_	
Switching time (turn-on delay time)	td(on)		_	17	_	
Switching time (rise time)	tr	$V_{DD} = -10 \text{ V}, I_D = -50 \text{ mA}$	_	42	_	ns
Switching time (turn-off delay time)	td(off)	$V_{GS} = 0$ to -4.5 V, $R_G = 10 \Omega$	_	420	_	
Switching time (fall time)	tf]	_	145	_	
Drain-Source forward voltage	V _{DSF}	$I_D = 100 \text{ mA}, V_{GS} = 0 \text{ V}$ (Note3)	_	0.83	1.2	V

Note3: Pulse test

Note4: If a forward bias is applied between gate and source, this device enters V(BR)DSX mode. Note that the drain-source breakdown voltage is lowered in this mode.

Switching Time Test Circuit



Precaution

Let V_{th} be the voltage applied between gate and source that causes the drain current (I_D) to be low (-100 μ A for this product). Then, for normal switching operation, $V_{GS(on)}$ must be higher than V_{th} , and $V_{GS(off)}$ must be lower than V_{th} . This relationship can be expressed as: $V_{GS(off)} < V_{th} < V_{GS(on)}$.

Take this into consideration when using the device.

Handling Precaution

When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.

Thermal resistance $R_{th\ (ch-a)}$ and power dissipation P_D vary depending on board material, board area, board thickness and pad area. When using this device, please take heat dissipation into consideration

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